ISL9R1560PF2 — STEALTH™ Diode



SEMICONDUCTOR®

ISL9R1560PF2 15A, 600V, STEALTH™ Diode

Feature

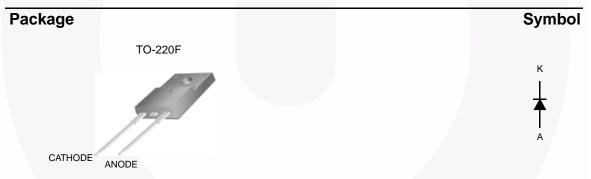
- Stealth Recovery t_{rr} = 29.4 ns (@ I_F = 15 A)
- Max Forward Voltage, $V_F = 2.2 V (@ T_C = 25^{\circ}C)$
- · 600 V Reverse Voltage and High Reliability
- Avalanche Energy Rated
- RoHS Compliant

Applications

- · Hard Switched PFC Boost Diode
- UPS Free Wheeling Diode
- Motor Drive FWD
- SMPS FWD
- Snubber Diode

Description

The ISL9R1560PF2 is a STEALTH™ diode optimized for low loss performance in high frequency hard switched applications. The STEALTH™ family exhibits low reverse recovery current (I_{RR}) and exceptionally soft recovery under typical operating conditions. This device is intended for use as a free wheeling or boost diode in power supplies and other power switching applications. The low I_{RR} and short ta phase reduce loss in switching transistors. The soft recovery minimizes ringing, expanding the range of conditions under which the diode may be operated without the use of additional snubber circuitry. Consider using the STEALTH™ diode with an SMPS IGBT to provide the most efficient and highest power density design at lower cost.

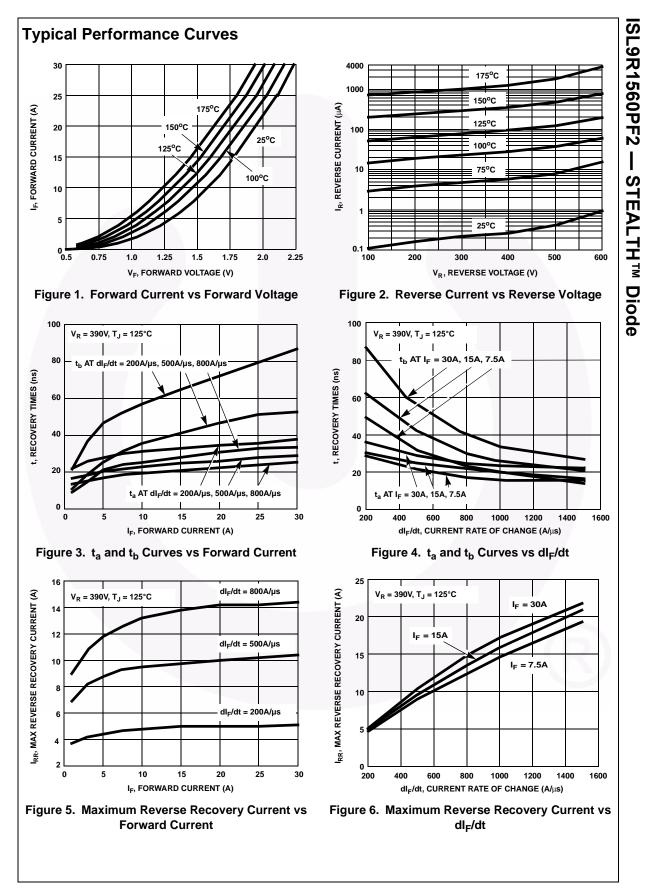


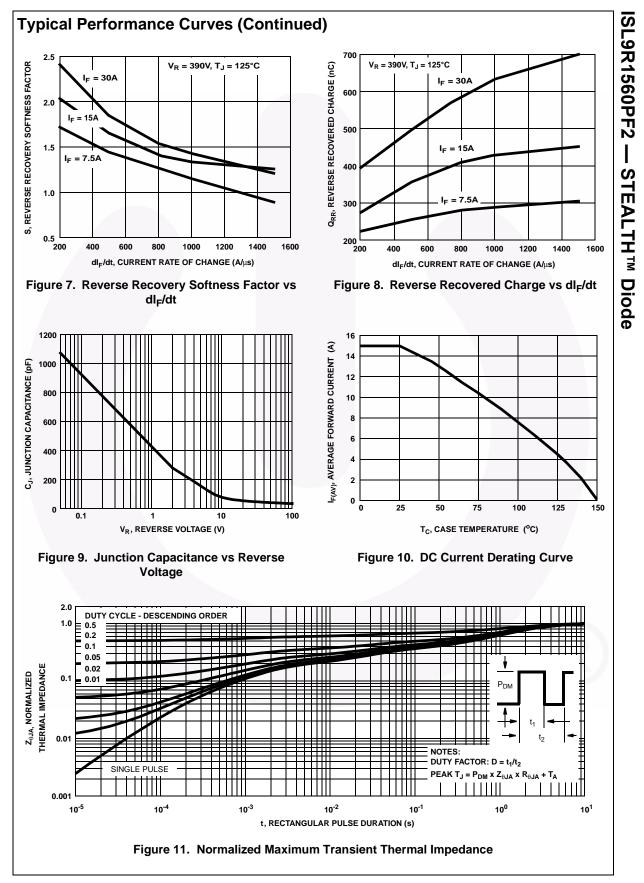
Device Maximum Ratings T_c = 25°C unless otherwise noted

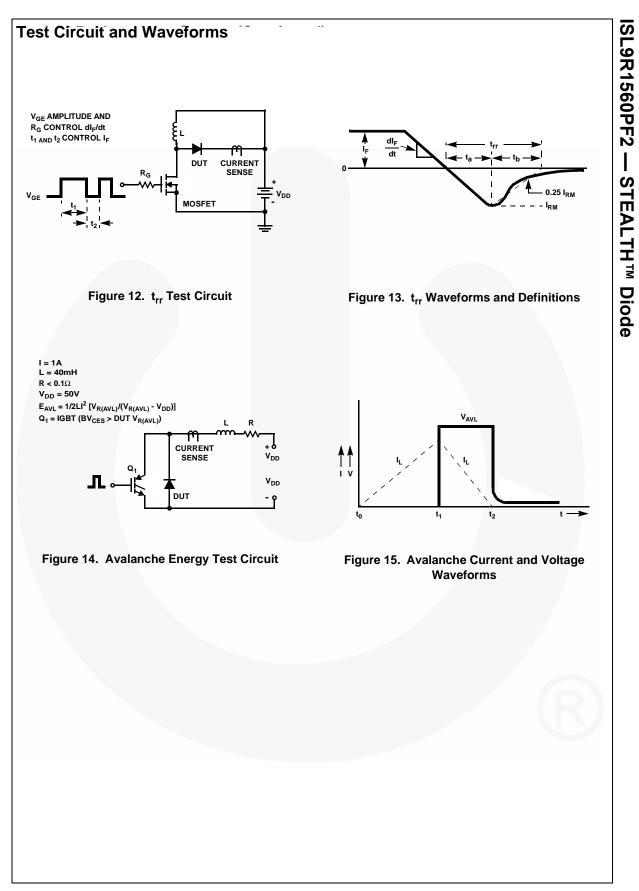
Symbol	Parameter	Rating	Unit
V _{RRM}	Repetitive Peak Reverse Voltage	600	V
V _{RWM}	Working Peak Reverse Voltage	600	V
V _R	DC Blocking Voltage	600	V
I _{F(AV)}	Average Rectified Forward Current (T _C = 25°C)	15	Α
I _{FRM}	Repetitive Peak Surge Current (20 kHz Square Wave)	30	А
I _{FSM}	Nonrepetitive Peak Surge Current (Halfwave 1 Phase 60 Hz)	200	Α
PD	Power Dissipation	30	W
E _{AVL}	Avalanche Energy (1 A, 40 mH)	20	mJ
Γ _J , T _{STG}	Operating and Storage Temperature Range	-55 to 150	°C
T _L Maximum Temperature for Soldering Leads at 0.063in (1.6 mm) from Case for 10s		300	°C

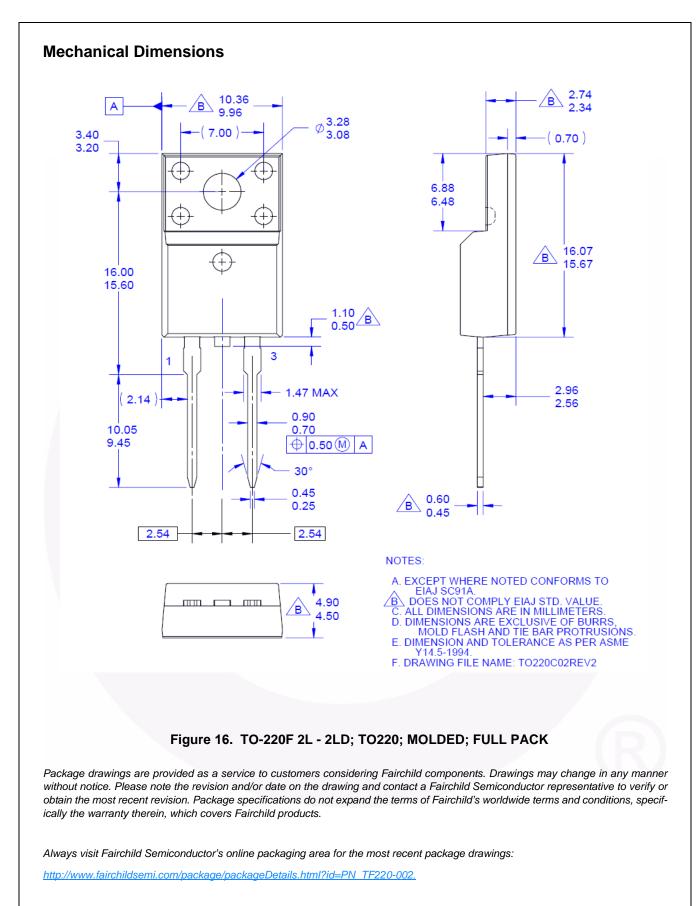
operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Device Marking Device R1560PF2 ISL9R1560P		Device	Package	ge Tape Width			Quantity	
		ISL9R1560PF2	TO-220F-2L N/A				50	
lectric	al Char	acteristics τ _c = 25°c	unless otherwise n	oted				
Symbol Parameter		Test Co	Test Conditions		Тур	Max	Units	
ff State	Charact	eristics						
I _R	Instantaneous Reverse Current		V _R = 600 V	T _C = 25°C	-	-	100	μA
i c				T _C = 125°C	-	-	1.0	mA
n State	Charact	eristics				•		
V _F	Instantaneous Forward Voltage		I _F = 15 A	T _C = 25°C	-	1.8	2.2	V
• F		g-	F	$T_{\rm C} = 125^{\circ}{\rm C}$	-	1.65	2.0	V
vnamic	Charact	eristics						
C.	Junction C		V _R = 10 V, I _F = 0 A		-	62	-	pF
Ů		-			1			
t _{rr}	ng Characteristics Reverse Recovery Time		I _F = 1 A, dI _F /dt = 100	0 Α/μs, V _R = 30 V	-	25	30	ns
			I _F = 15 A, dI _F /dt = 10	I _F = 15 A, dI _F /dt = 100 A/µs, V _R = 30 V		35	40	ns
t _{rr}	Reverse R	ecovery Time	$I_F = 15 \text{ A},$ $dI_F/dt = 200 \text{ A}/\mu\text{s},$ $V_R = 390 \text{ V}, \text{ T}_C = 25^{\circ}\text{C}$ $I_F = 15 \text{ A},$		-	29.4	-	ns
۱ _m	Maximum	Reverse Recovery Current			-	3.5	-	Α
Q _{rr}	Reverse R	ecovered Charge			-	57	-	nC
t _{rr}	Reverse R	ecovery Time			-	90	-	ns
S	Softness F	actor (t _b /t _a)	$dI_F/dt = 200 \text{ A}/\mu \text{s},$	$dI_F/dt = 200 A/\mu s,$		2.0	-	
l _{rr}	Maximum	Reverse Recovery Current	$V_{R} = 390 V,$		-	5.0	-	Α
Q _{rr}		ecovered Charge	— T _C = 125°C	-	275	-	nC	
t _{rr}	Reverse R	ecovery Time	I _F = 15 A,		-	52	-	ns
S	Softness F	actor (t _b /t _a)	dI _F /dt = 800 A/μs,				-	
I _{rr}	Maximum	Reverse Recovery Current	V _R = 390 V,	V _R = 390 V,				Α
Q _{rr}		ecovered Charge	$T_{\rm C} = 125^{\circ}{\rm C}$ - 390 -				nC	
dl _M /dt		di/dt during t _b	-			800	-	A/µs
hermal	Characte	eristics						
R _{θJC}		esistance Junction to Case			-	-	4.1	°C/W
000			t TO-247			1		°C/W











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